

# Joseph F. Gogan Jr.

716-951-0256 | jfgogan@buffalo.edu | linkedin.com/in/josephgogan

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## EDUCATION

**M.S.: Electrical Engineering**, University at Buffalo, State University of New York, May 2024 GPA: 3.8  
**B.S.: Electrical Engineering**, University at Buffalo, State University of New York, May 2023 GPA: 3.5  
**Minor: Mathematics**, University at Buffalo, State University of New York, May 2023  
**High School Diploma**: Canisius High School, Buffalo, New York, May 2019 GPA: 3.7

## SKILLS & TOOLS

**Languages**: C, C++, Java, Matlab, Perl, Python, VHDL, HTML, CSS, JavaScript  
**Tools**: Excel, LTSpice, Multisim, Jupyter, Visual Studio, Code Composer, Epsilon, Xilinx, ADS

## ENGINEERING PROJECTS

**Wind Turbine Design Project**: Fall 2019

- Performed 30+ tests of 6 unique designs to optimize power production from empirical data.

**IEEE Battle-Bots Competition**: Spring 2022

- Assisted building with workshop machinery, performing various modifications leading up to competition.
- Soldered and made other repairs during competition between rounds.

**Non-Contact Frequency Detector**: Spring 2023

- Designed and assembled original radar based frequency detector for group Senior Design Project.
- Coded Signal Processing methods of Demodulation, Filters, Windowing, and FFT, independently.

## RELEVANT COURSES

**Circuit Analysis + Electronic Devices and Circuits Lab**: Fall 2020 + Fall 2021 + Spring 2022

- Learned fundamentals of circuit design and then experimented with lab equipment, building various circuits, like amplifiers.

**Introduction to Programming**: Spring 2021

- Practiced fundamentals of C/C++ and Matlab operations.

**Signals and Systems + Communication Systems**: Spring 2021+ Spring 2022

- Studied the concepts of digital signal processing with various filters and transmission methods.

**Applied Electromagnetics**: Fall 2021

- Learned applications of induced magnetic fields in more depth from Physics in addition to Smith charts.

**Embedded Systems + HDL Based Digital Design**: Spring 2022 + Fall 2022

- Utilized a Zyboard system through Xilinx interface to perform various C and VHDL focused projects.

**Introduction to Digital Signal Processing**: Spring 2021

- Discussed multiple techniques in DSP including little/big endian processing, filtering, and windowing.
- Researched applications of ORB in place of SIFT and SURF as image processing techniques.

**RF/Microwave Circuits**: Fall 2023

- Discussed in more depth RF technology and equations including antennas.
- Simulated solutions to problems with Keysight ADS software in lab section.

## WORK EXPERIENCE

**Engineering Intern, Vocal Technologies, Buffalo, NY**: July 2022 – Present

- Produced various digital signal processing projects alone or in small teams, including filters, echo cancellation, psychoacoustics and voice quality enhancement.
- Completed projects operating C/C++ based source code, along with projects in VHDL and Matlab.

**Dairy Customer Service, Wegmans Food Markets, Buffalo, NY**: December 2019 – September 2022

- Led small team to maintain department, by assigning tasks and training new hires.
- Maintained product in multiple locations with organizational skills to store excess product.

## INVOLVEMENT

**Treasurer, SHPE Student Chapter, University at Buffalo, May 2022 - May 2023**

- Assisted in reforming club with President after it went inactive for COVID.
- Hosted events for engagement and networking and lead workshops for machinery.

**Treasurer, UBMusicians Club, University at Buffalo, January 2020 - May 2022**

- Managed equipment and purchases while organizing sessions for members to play together.

**Member, IEEE Student Chapter, University at Buffalo, August 2019 – May 2022**

- Collaborated on research during Battle-Bots assembly and Micro-Mouse meetings.